

HCM1A0805

Automotive grade High current power inductors



Product features

- AEC-Q200 Grade 1 qualified
- High current carrying capacity
- Magnetically shielded, low EMI
- Frequency range up to 1 MHz
- Inductance range from 3.3 μ H to 100 μ H
- Current range from 1.5 A to 10 A
- 8.3 mm x 8.0 mm footprint surface mount package in a 5.4 mm height
- Alloy powder core material
- Moisture Sensitivity Level (MSL): 1

Applications

- Body electronics
 - Central body control module
 - Vehicle access control system
 - Headlamps, tail lamps and interior lighting
 - Heating ventilation and air conditioning controllers (HVAC)
 - Doors, window lift and seat control
- Advanced driver assistance systems
 - Adaptive cruise control (ACC)
 - Automatic parking control
 - Collision avoidance system/ Car black box system
- Infotainment and cluster electronics
 - Audio subsystem: head unit and trunk amp
 - Digital instrument cluster
 - In-vehicle infotainment (IVI) and navigation
 - Port power/USB HUB for front and rear passengers
- Chassis and safety electronics
 - Airbag control unit
 - Electronic stability control system (ESC)
- Engine and Powertrain Systems
 - Electric pumps, motor control and auxiliaries
 - Powertrain control module (PCU)/Engine Control unit (ECU)
 - Transmission Control Unit (TCU)

Environmental Data

- Storage temperature range (Component): -55 °C to +155 °C
- Operating temperature range: -55 °C to +155 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant



Product Specifications

Part Number ⁶	OCL ¹ (μH) $\pm 20\%$	FLL ² (μH) minimum	I_{rms} ³ (A)	I_{sat} ⁴ (A)	DCR (m Ω) typical @ +20 °C	DCR (m Ω) maximum @ +20 °C	K-factor ⁵
HCM1A0805-3R3-R	3.3	2.1	8.0	8.0	9.0	10	180
HCM1A0805-4R7-R	4.7	3.0	5.7	10	17	20	87
HCM1A0805-100-R	10	6.4	2.8	8.0	50	55	48
HCM1A0805-150-R	15	9.6	2.5	6.0	64	71	48
HCM1A0805-220-R	22	14	2.0	3.8	100	110	39
HCM1A0805-470-R	47	30	1.8	3.2	145	160	31
HCM1A0805-101-R	100	64	1.5	2.7	240	265	20

1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.25 V_{rms}, 0.0 Adc, +25 °C

2. Full Load Inductance (FLL) Test Parameters: 100 kHz, 0.25 V_{rms}, I_{rms}, +25 °C

3. I_{rms}: DC current for an approximate temperature rise of 30 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 155 °C under worst case operating conditions verified in the end application.

4. I_{sat}: Peak current for approximately 20% rolloff @ +25 °C

5. K-factor: Used to determine B_{pp} for core loss (see graph). Bp-p = K * L * ΔI . B_{pp}: (Gauss), K: (K-factor from table), L: (Inductance in μH), ΔI (Peak to peak ripple current in Amps).

6. Part Number Definition: HCM1A0805-xxx-R

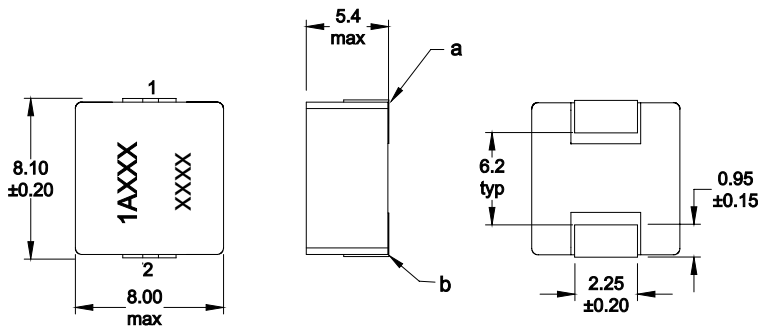
HCM1A0805 = Product code and size

xxx = inductance value in μH , R = decimal point,

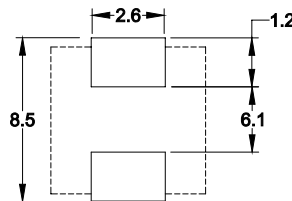
If no R is present then last character equals number of zeros

-R suffix = RoHS compliant

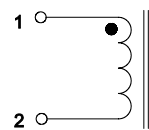
Dimensions (mm)



Recommended Pad Layout



Schematic



Part marking: 1AXXX=automotive grade, XXX=inductance value in μH , R=decimal point. If no R is present then last character equals number of zeros. xxxx=Lot code

All soldering surfaces to be coplanar within 0.1 millimeters

Tolerances are ± 0.3 millimeters unless stated otherwise

DCR measured from point "a" to point "b"

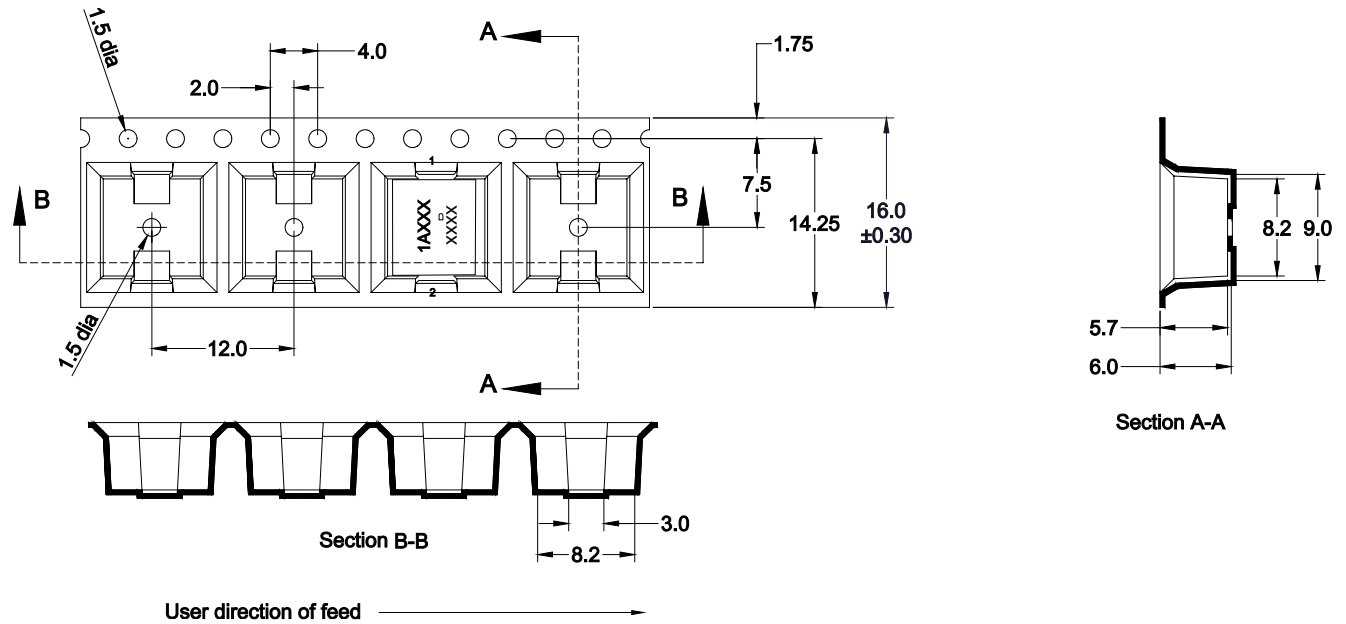
Color: Grey

Do not route traces or vias underneath the inductor

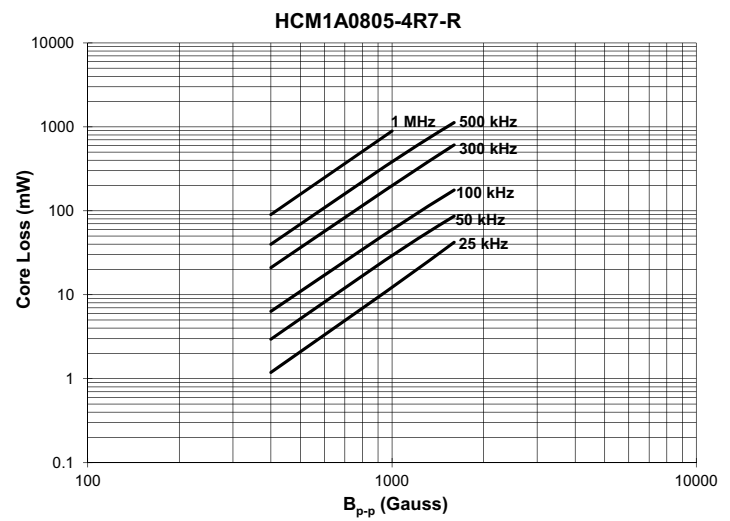
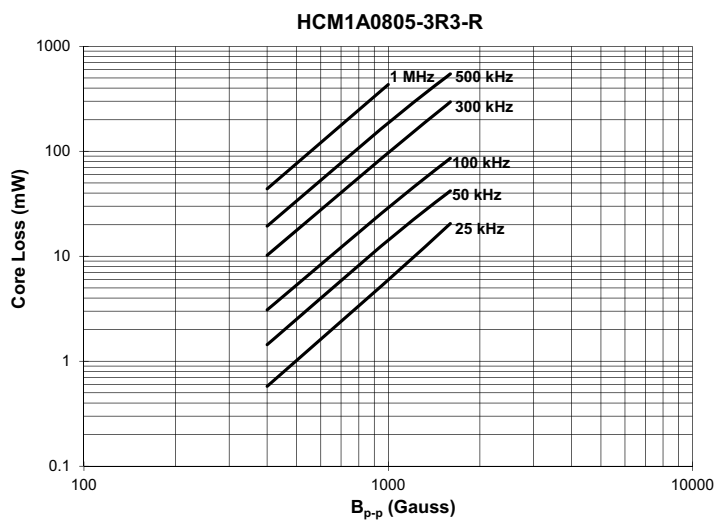
Packaging information (mm)

Drawing not to scale

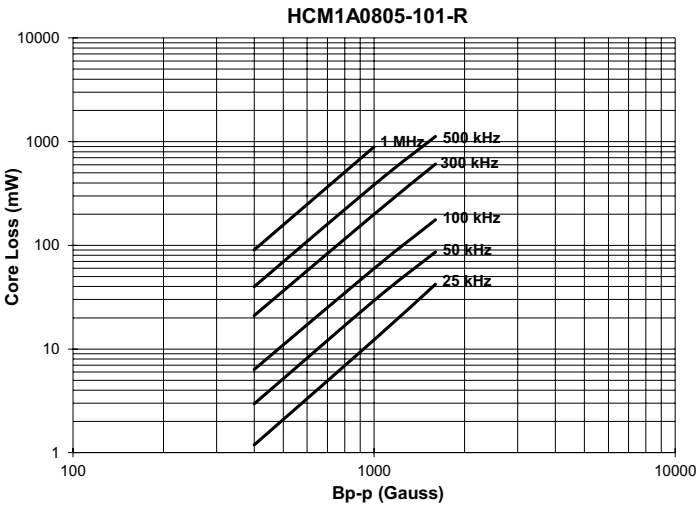
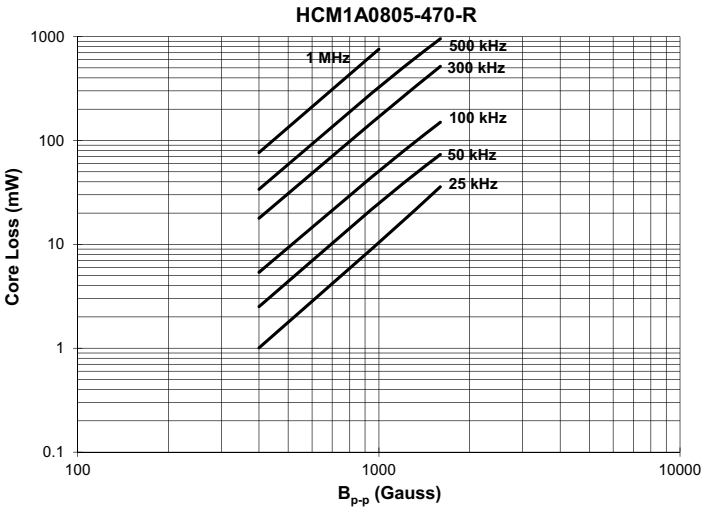
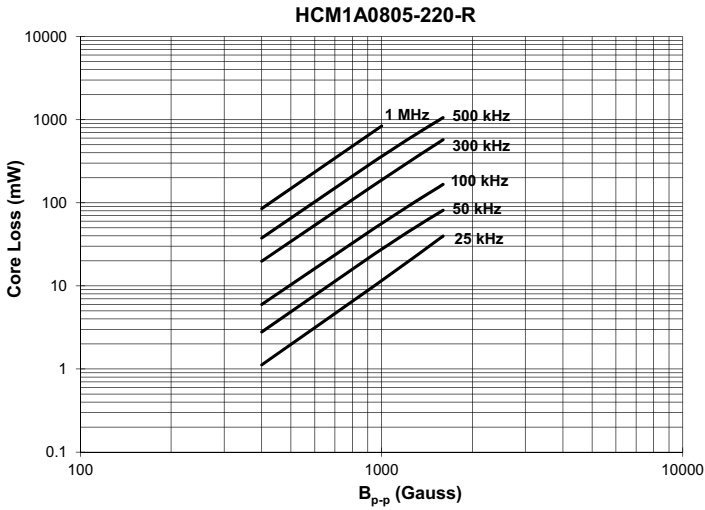
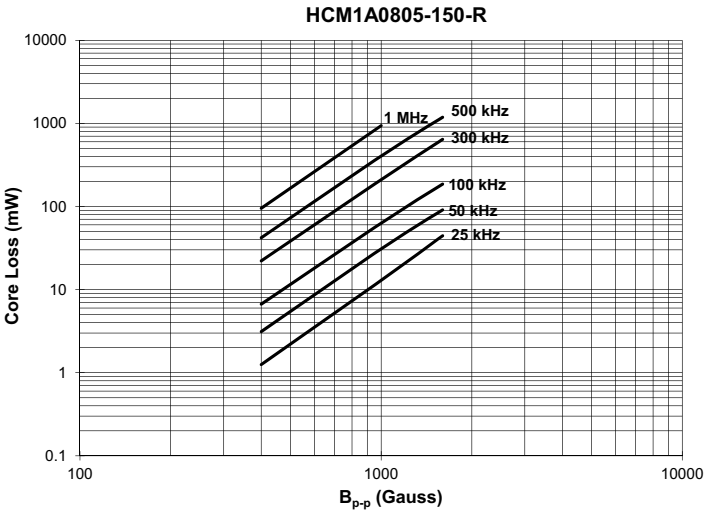
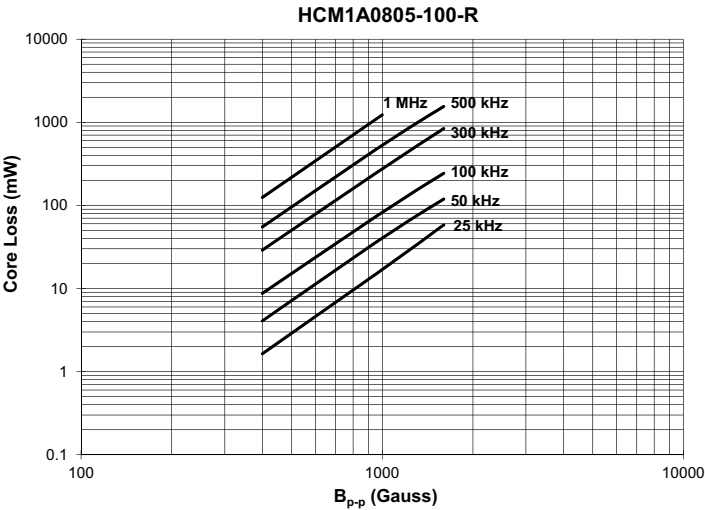
Supplied in tape and reel packaging ,500 parts per 13" diameter reel



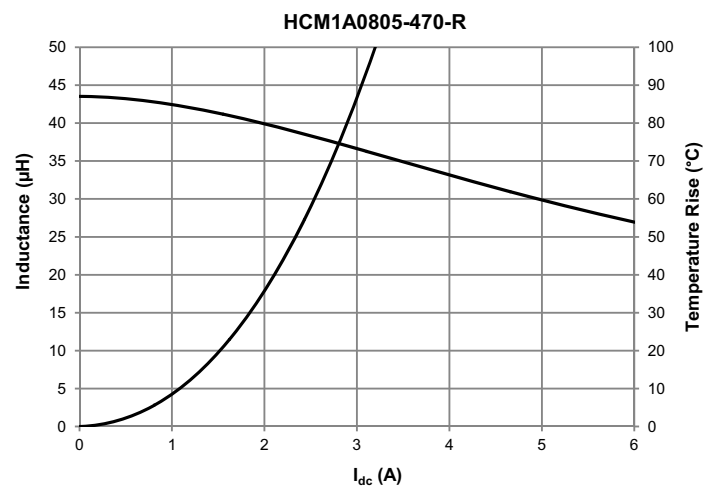
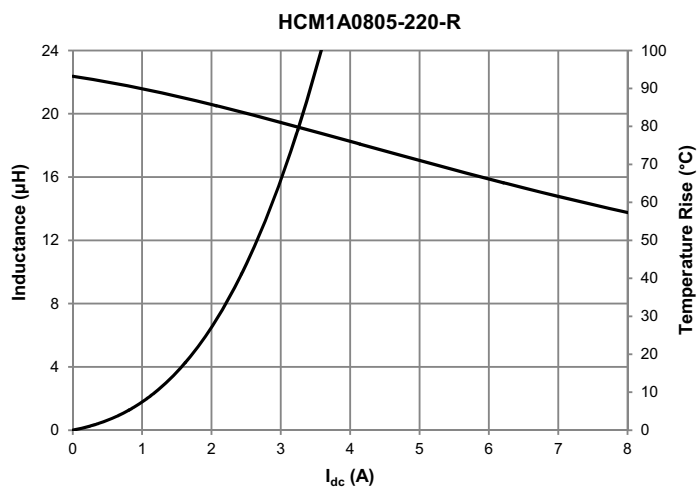
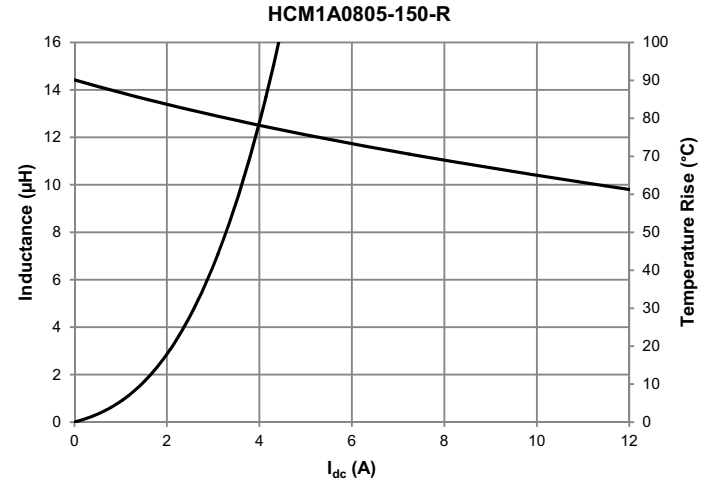
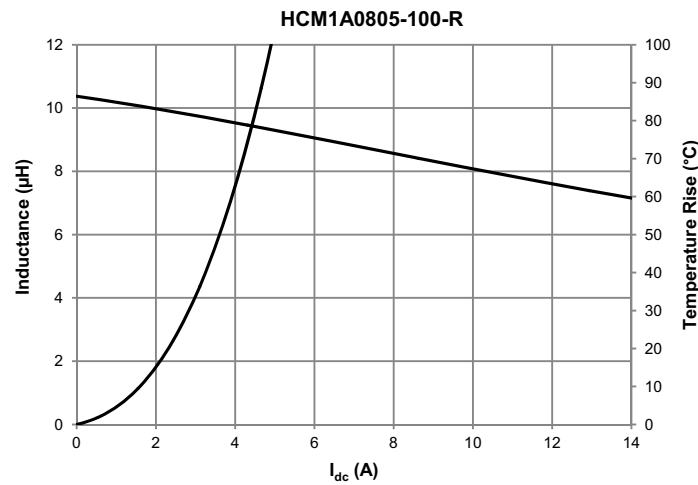
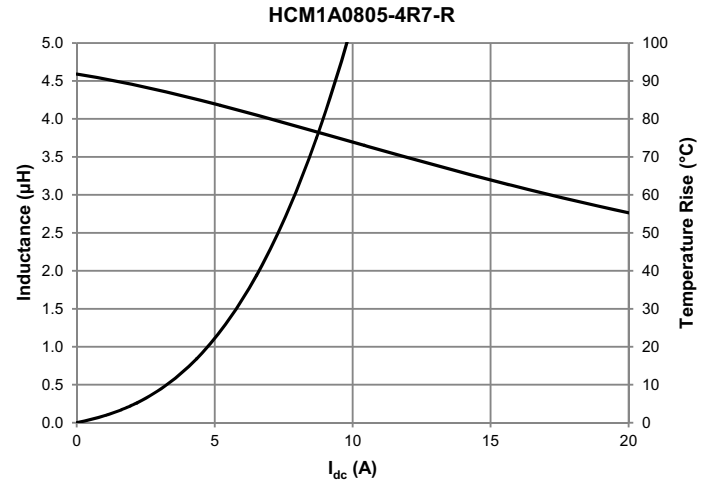
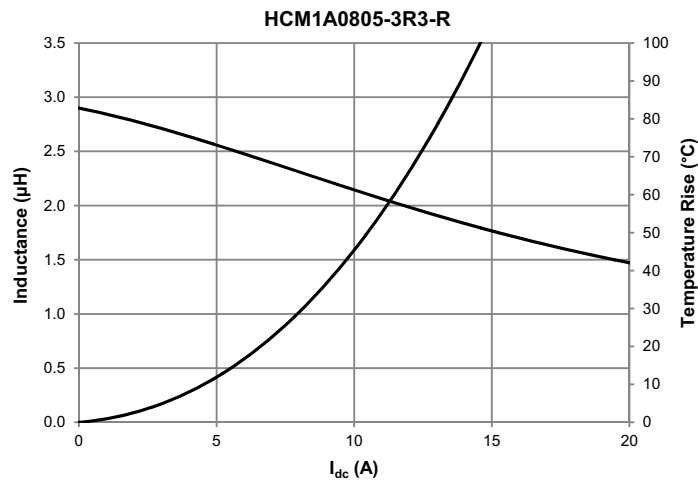
Core loss vs Bp-p



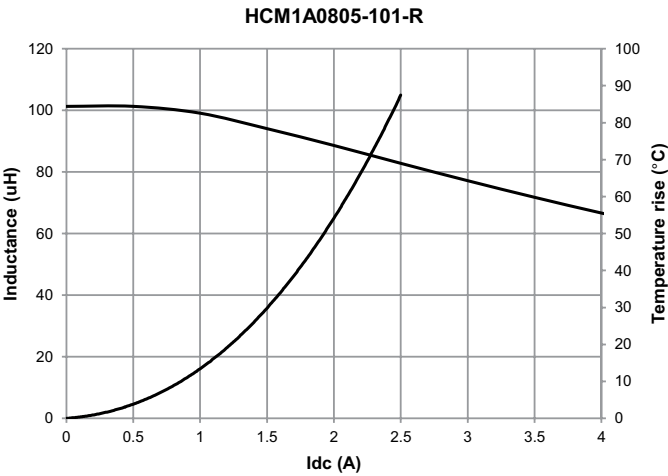
Core loss vs Bp-p



Inductance and temperature rise vs. current



Inductance and temperature rise vs. current



Solder reflow profile

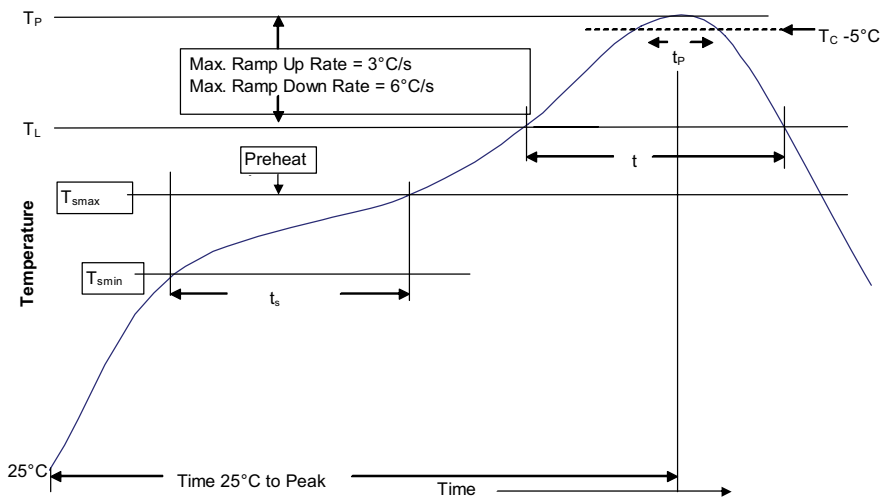


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T_{smin})	100°C	150°C
• Temperature max. (T_{smax})	150°C	200°C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_P	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L)	183°C	217°C
Time at liquidous (t_L)	60-150 Seconds	60-150 Seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_P)** within 5 °C of the specified classification temperature (T_C)	20 Seconds**	30 Seconds**
Average ramp-down rate (T_P to T_{smax})	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_P) is defined as a supplier minimum and a user maximum.

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